

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT6157237

<b>SUBMISSION TYPE:</b>	NEW ASSIGNMENT
<b>NATURE OF CONVEYANCE:</b>	ASSIGNMENT
<b>CONVEYING PARTY DATA</b>	
<b>Name</b>	<b>Execution Date</b>
NAGESH VODRAHALLI	10/06/2019
SHRIKAR BHAGATH	03/11/2020
CHIH YANG LI	02/24/2020
SRINIVASAN SIVARAM	04/27/2020
RAMA SHUKLA	06/16/2020
<b>RECEIVING PARTY DATA</b>	
<b>Name:</b>	SANDISK TECHNOLOGIES LLC
<b>Street Address:</b>	5080 SPECTRUM DRIVE, SUITE 1050W
<b>City:</b>	ADDISON
<b>State/Country:</b>	TEXAS
<b>Postal Code:</b>	75001
<b>PROPERTY NUMBERS Total: 1</b>	
<b>Property Type</b>	<b>Number</b>
<b>Application Number:</b>	16816495
<b>CORRESPONDENCE DATA</b>	
<b>Fax Number:</b>	(415)489-4150
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i>	
<b>Phone:</b>	415-489-4100
<b>Email:</b>	lmiller@vierramagen.com
<b>Correspondent Name:</b>	VIERRA MAGEN MARCUS LLP
<b>Address Line 1:</b>	2001 JUNIPERO SERRA BLVD., STE. 515
<b>Address Line 4:</b>	DALY CITY, CALIFORNIA 94014
<b>ATTORNEY DOCKET NUMBER:</b>	SAND-02422US0
<b>NAME OF SUBMITTER:</b>	BRIAN I. MARCUS
<b>SIGNATURE:</b>	/BRIAN I. MARCUS/
<b>DATE SIGNED:</b>	06/17/2020
<b>Total Attachments: 7</b>	
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## SOLE TO CORPORATE ASSIGNMENT

WHEREAS, the undersigned, Nagesh Vodrahalli, a resident of Los Altos, California (hereinafter termed "Inventor"), has invented certain new improvements in:

### MEMORY SCALING SEMICONDUCTOR DEVICE

and has executed a declaration for an application for a United States patent disclosing and identifying the invention, the declaration being executed on Oct 6, 2019

WHEREAS SanDisk Technologies LLC (hereinafter termed "Assignee"), a limited liability company of the State of Texas, having a place of business at 5080 Spectrum Drive, Suite 1050W, Addison, State of Texas, 75001, wishes to acquire the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered by said Inventor (all collectively hereinafter termed "said invention"), and in and to any and all patents, certificates of invention and other forms of protection thereon (hereinafter termed "patents") applied for or granted in the United States and/or other countries.

NOW THEREFORE, for good and valuable consideration acknowledged by said Inventor to have been received in full from said Assignee:

1. Said Inventor does hereby sell, assign, transfer and convey unto said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply in any and all countries of the world for patents, certificates of inventions or other governmental grants on said invention, including the right to apply for patents pursuant to the International Convention for the Protection of Industrial Property or pursuant to any other convention, treaty, agreement or understanding; (c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; (d) in and to each and every reissue or extension of any of said patents; and (e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

2. Said Inventor hereby covenants and agrees to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and other countries. Such cooperation by said Inventor shall include prompt production of pertinent facts and documents, giving of testimony, executing of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for complying with any duty of disclosure; (c) for prosecuting any of said applications; (d) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (e) for filing and prosecuting applications for reissue of any of said patents; (f) for interference or other priority proceedings involving said invention; and (g)

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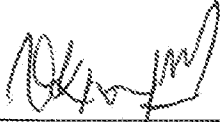
**PATENT**  
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for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, reexamination proceedings, compulsory licensing proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventor in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this Assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventor, said Inventor's heirs, legal representatives and assigns.

4. Said Inventor hereby warrants and represents that said Inventor has not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

Dated: Oct 6, 2019

  
\_\_\_\_\_  
Nagesh Vodrahalli

## **JOINT TO CORPORATE ASSIGNMENT**

WHEREAS, the undersigned Inventors:

Shrikar Bhagath, a resident of San Jose, California;

Chih Yang Li, a resident of Menlo Park, California;

Srinivasan Sivaram, a resident of Los Gatos, California; and

Rama Shukla, a resident of Saratoga, California,

have invented certain new and useful improvements in:

### **MEMORY SCALING SEMICONDUCTOR DEVICE**

and have executed a declaration for an application for a United States Patent disclosing and identifying the invention, the declaration being executed on 03/11/2020; 02/24/2020; 04/27/2020; 06/16/2020

WHEREAS SanDisk Technologies LLC (hereinafter termed "Assignee"), a limited liability company of the State of Texas, having a place of business at 5080 Spectrum Drive, Suite 1050W, Addison, State of Texas, 75001, wishes to acquire the entire right, title and interest in and to said application and the invention disclosed therein, and in and to all embodiments of the invention, heretofore conceived, made or discovered jointly or severally by said Inventors (all collectively hereinafter termed "said invention"), and in and to any and all patents, certificates of invention and other forms of protection thereon (hereinafter termed "patents") applied for or granted in the United States and/or other countries.

NOW THEREFORE, for good and valuable consideration acknowledged by each of said Inventors to have been received in full from said Assignee:

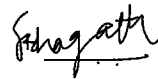
1. Said Inventors do hereby sell, assign, transfer and convey to said Assignee, the entire right, title and interest (a) in and to said application and said invention; (b) in and to all rights to apply in any or all countries of the world for patents, certificates of inventions or other governmental grants on said invention, including the right to apply for patents pursuant to the International Convention for the Protection of Industrial Property or pursuant to any other convention, treaty, agreement or understanding; (c) in and to any and all applications filed and any and all patents, certificates of inventions or other governmental grants granted on said invention in the United States or any other country, including each and every application filed and each and every patent granted on any application which is a division, substitution, or continuation of any of said applications; (d) in and to each and every reissue or extension of any of said patents; and (e) in and to each and every patent claim resulting from a reexamination certificate for any and all of said patents.

2. Said Inventors hereby jointly and severally covenant and agree to cooperate with said Assignee to enable said Assignee to enjoy to the fullest extent the right, title and interest herein conveyed in the United States and other countries. Such cooperation by said Inventors shall include prompt production of pertinent facts and documents, giving of testimony, executing of petitions, oaths, specifications, declarations or other papers, and other assistance all to the extent deemed necessary or desirable by said Assignee (a) for perfecting in said Assignee the right, title and interest herein conveyed; (b) for complying with any duty of disclosure; (c) for prosecuting any of said applications; (d) for filing and prosecuting substitute, divisional, continuing or additional applications covering said invention; (e) for filing and prosecuting applications for reissue of any of said patents; (f) for interference or other priority proceedings involving said invention; and (g) for legal proceedings involving said invention and any applications therefor and any patents granted thereon, including without limitation opposition proceedings, cancellation proceedings, priority contests, public use proceedings, reexamination proceedings, compulsory licensing proceedings, infringement actions and court actions; provided, however, that the expense incurred by said Inventors in providing such cooperation shall be paid for by said Assignee.

3. The terms and covenants of this Assignment shall inure to the benefit of said Assignee, its successors, assigns and other legal representatives, and shall be binding upon said Inventors, their respective heirs, legal representatives and assigns.

4. Said Inventors hereby jointly and severally warrant and represent that they have not entered and will not enter into any assignment, contract, or understanding in conflict herewith.

Date: 3/11/2020



\_\_\_\_\_  
Shrikar Bhagath

Date: 2/24/2020

  
\_\_\_\_\_  
Chih Yang Li

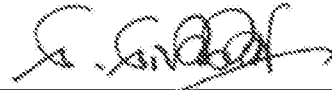
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Date: 4.27.20



Srinivasan Sivaram



Date: 6/16/2020



Rama Shukla

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**RECORDED: 06/17/2020**

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